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Switch Mode Power Rectifiers MBR8H100MFS, NRVB8H100MFS

Features

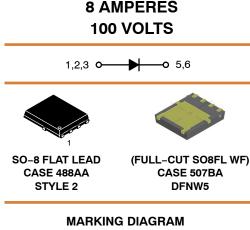
- Low Power Loss / High Efficiency
- New Package Provides Capability of Inspection and Probe After Board Mounting
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 175°C Operating Junction Temperature
- WF Suffix for Products with Wettable Flanks
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb–Free Devices
- **Mechanical Characteristics:**
- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94–0 @ 0.125 in.
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|--|-------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 100 | V |
| Average Rectified Forward Current (Rated V _R , T _C = 165°C) | I _{F(AV)} | 8.0 | A |
| Peak Repetitive Forward Current, (Rated V _R , Square Wave, 20 kHz, T _C = 162°C) | I _{FRM} | 16 | A |
| Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) | I _{FSM} | 75 | A |
| Storage Temperature Range | T _{stg} | -65 to +175 | °C |
| Operating Junction Temperature | Τ _J | –55 to +175 | °C |
| Unclamped Inductive Switching Energy (10 mH Inductor, Non-repetitive) | E _{AS} | 75 | mJ |
| ESD Rating (Human Body Model) | | 3B | |
| ESD Rating (Machine Model) | | M4 | |

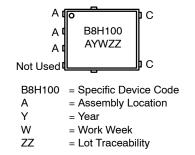
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

NOTE: The heat generated must be less than the thermal conductivity from Junction-to-Ambient: dPD/dTJ < 1/RJA



SCHOTTKY BARRIER

RECTIFIERS



ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-------------------|----------------------|-----------------------|
| MBR8H100MFST1G | SO-8 FL (Pb-Free) | 1500 / Tape & Reel |
| NRVB8H100MFSWFT1G | SO-8 FL (Pb-Free) | 1500 / Tape & Reel |
| NRVB8H100MFSWFT3G | SO-8 FL (Pb-Free) | 5000 / Tape & Reel |

DISCONTINUED (Note 1)

| MBR8H100MFST3G | SO-8 FL (Pb-Free) | 5000 / Tape & Reel |
|-----------------|----------------------|-----------------------|
| NRVB8H100MFST1G | SO-8 FL (Pb-Free) | 1500 / Tape & Reel |
| NRVB8H100MFST3G | SO-8 FL (Pb-Free) | 5000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

 DISCONTINUED: These devices are not recommended for new design. Please contact your onsemi representative for information. The most current information on these devices may be available on www.onsemi.com.

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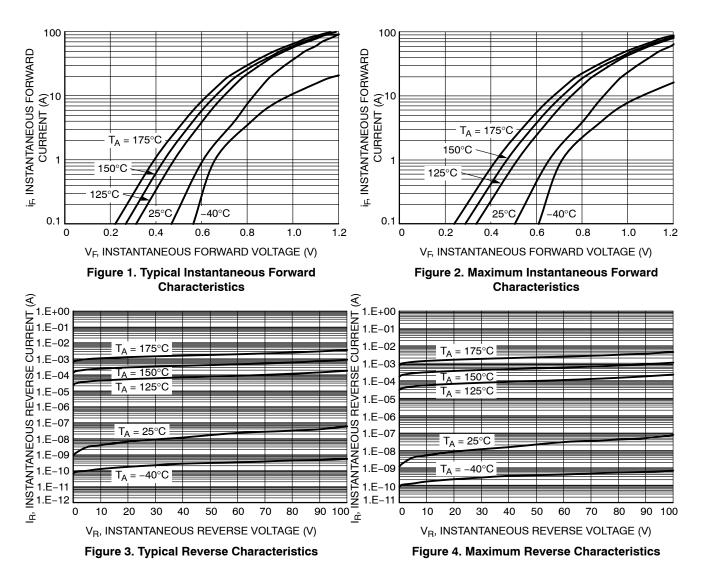
THERMAL CHARACTERISTICS

| Characteristic | Symbol | Тур | Max | Unit |
|--|-----------------------|-----|------|------|
| Thermal Resistance, Junction-to-Case, Steady State (Assumes 600 mm ² 1 oz. copper bond pad, on a FR4 board) (Note 2) | $R_{	extsf{	heta}JC}$ | - | 2.2 | °C/W |
| Thermal Resistance, Junction-to-Ambient, Steady State (Note 2) | R _{0JA} | - | 53.1 | °C/W |
| ELECTRICAL CHARACTERISTICS | | | | |
| Instantaneous Forward Voltage (Note 1) | ٧ _F | | 0.50 | V |

| (i _F = 8 Amps, T _J = 125°C) (i _F = 8 Amps, T _J = 25°C) | | 0.68 0.81 | 0.76 0.90 | | |
|---|----------------|--------------|--------------|----|---|
| Instantaneous Reverse Current (Note 1) | i _R | | | μΑ | |
| (Rated dc Voltage, T _J = 125°C) | | 180 | 300 | | l |
| (Rated dc Voltage, T _J = 25°C) | | 0.06 | 2 | | l |

1. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

2. Surface-mounted on FR4 board using a 650 mm², 1 oz. Cu pad.



TYPICAL CHARACTERISTICS

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TYPICAL CHARACTERISTICS

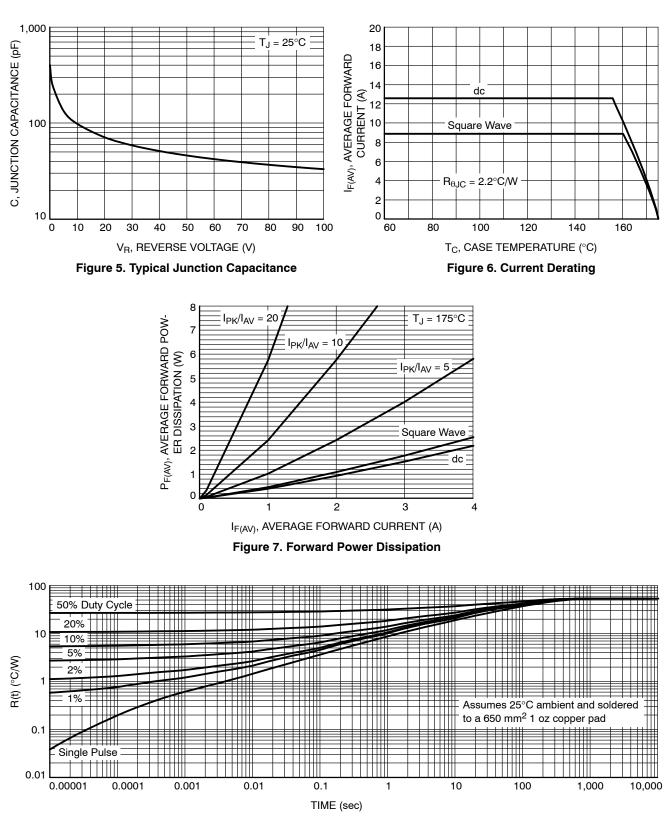
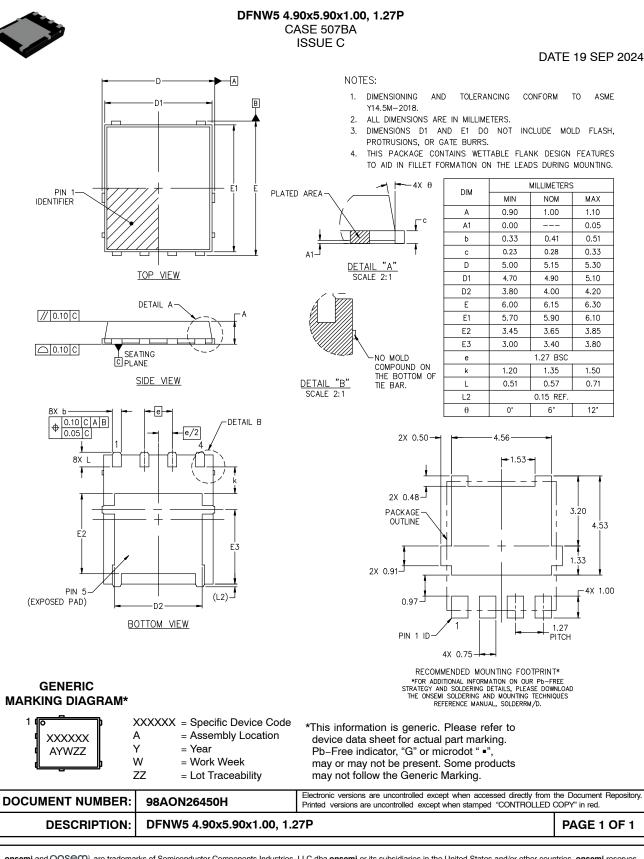


Figure 8. Thermal Response

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